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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ju-Won CHO	04/22/2013
Dan-Bi KANG	04/22/2013
Tae-Hun KIM	04/22/2013

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.	
Street Address:	129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-742	
City:	Suwon-si	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	29452774	

CORRESPONDENCE DATA

Fax Number: 2023153758

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2024290020

Email: info@nsiplaw.com

Correspondent Name: NSIP Law

Address Line 1: PO Box 65745

Address Line 4: Washington, DISTRICT OF COLUMBIA 20035

ATTORNEY DOCKET NUMBER:	D91098.0754
NAME OF SUBMITTER:	Charles Y. Park
Signature:	/Charles Y. Park/
Date:	04/25/2013

Total Attachments: 2

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PATENT REEL: 030282 FRAME: 0940

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

filed on	(if applicable), entitled:
	EARPHONE GLASSES
The above-identified applic	ation was made or authorized to be made by me.
I believe I am the original in application.	nventor or an original joint inventor of a claimed invention in the above-identified
	any willful false statement made in this declaration is punishable under 18 USC 1001 not more than five (5) years, or both.
I have reviewed and under	stand the contents of the above-identified application, including the claims.
to be material to patentabil information that became a	isclose to the United States Patent and Trademark Office all information known to me ity as defined in 37 CFR 1.56, including for continuation-in-part applications, material vailable between the filing date of the prior application and the national or PCT he continuation-in-part application.
	ASSIGNMENT
For valuable consideration	, I, as a below-named assignor, hereby assign to:
Samsung Electron 129, Samsung-ro, Suwon-si, Gyeong Republic of Korea	Yeongtong-gu gì-do, 443-742
and its successors and ass	signs (collectively hereinafter called "the Assignee"), the entire right, title, and interest
throughout the world in the	inventions and improvements that are the subject of the application identified in the
	s United States Application Number or PCT International Application Number

models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the international Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further

This Assignment includes the above-identified application, any and all United States and foreign patents, utility

known, and to correct any typographical errors that may be discovered in this Assignment.

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COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	CHO, Ju-Won		
Inventor's Signature		Date	50 (S. 4.22
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	#5-213, Jamsii Misung APT., Shinchun-Dong, Songpa-Gu, Seoul, Republic of Korea		

Inventor's Legal Name	KANG, Dan-Bi			
Inventor's Signature	Danki (Cong	Date	some year	
Residence (City, Country)	Seoul, Republic of Korea			
Mailing Address	#101, 334-36 Seogyo1-Dong, Mapo-Gu, Seoul, Republic of Korea			

Inventor's Legal Name	KIM, Tae-Hun		
Inventor's Signature	Mar.	Date	2018 - 9122
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	#D-2301, Tower-Palace, 467 Dogok-Dong, Kangnam-Gu, Seoul, Republic of Korea		